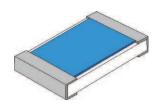


M32159/11 Zero Ohm Chip Resistor

Surface Mount, Jumper



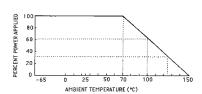
PERFORMANCE

Termination Material	B/G	C	U
Maximum Resistance	0.030 Ω	0.060 Ω	0.150 Ω
Maximum Current	1.2A	0.82A	0.52A
Maximum Power Rating		40 mW	

ENVIRONMENTAL PERFORMANCE

Thermal Shock Low Temperature Operation	Not to exceed maximum value
Short-time Overload	"
Resistance to Bonding Exposure	"
Moisture Resistance	"
High Temperature Exposure	u
Life	u

POWER DERATING



Percentage of power to be applied at various ambient temperatures. Full rated power to 70°, linerarly derated to 0 power at 150°C.

FEATURES

- Operating temperature range : -55° C to +150° C
- Solderable (termination material B) termination pretinned with SN60 over nickel barrier suitable for solder reflow vapor phase or wave solder attachment.
- MIL-PRF-55342 "S" level qualified manufacturer
- Epoxy Bondable terminations available with silver based (C), platinum gold (U) and gold (G) finishes for epoxy attachment.

PRODUCT LEVELS

All product levels are based on the same design. Level C is a Non-Established Reliability part requiring no group A, B or C testing. Military product level M is subject to group A, B and C testing per MIL-PRF-32159. Space product level T requires group A and B tests performed on a production lot basis, including 100% power conditioning.

MECHANICAL	INCHES	MILIMETERS	
Width Thickness Top Term Bottom Term Gap	.042 (.034050) .022 (.017027) .018 (.010033) .008 (.005015) .008 (.005015) .026 (.022030) .00108 grams	1.07 (0.86 - 1.27) 0.56 (0.43 - 0.69) 0.46 (0.25 - 0.84) 0.20 (0.13 - 0.38) 0.20 (0.13 - 0.38) 0.66 (0.56 - 0.76)	

Solderability: (Termination material (B) Solder coating compatible with Sn60, 62 or 63 solders, provides good wetting with all types of solder attachment. All product is tested IAW Mil-Std-202, method 208, including 8 hour steam aging.

PART NUMBERING

M32159 B 11 M

PRODUCT LEVEL DESIGNATOR* M: Military C: Industrial T: Space Level

Size Code: RCZ1010 /11 = 0.040 X 0.020 X 0.015

Termination Material:

- B: Solderable
- C: Silver based epoxy bondable
- G: Gold epoxy bondáble
- U: Pt Au epoxy bondable

PACKAGING

Two packaging options are available:

Waffle Pack - (360 per Tray Max.) Tape & Reel - (5000 per 8" Inch Reel Max.)

OPTIONS

SOTA offers a full line of thick & thin film resistors in the 0402 size including Standard Grade, High-Reliability (customer specified testing). Custom part marking is available.

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